## 2.5 V / 3.3 V Differential and LVTTL/LVCMOS 2:1 MUX to 1:12 LVCMOS Fanout

#### Description

The NB3L83948C is a pure 2.5 V / 3.3 V ( $V_{DD} = V_{DDO}$ ) or mixed mode 3.3 V Core ( $V_{DD}$ ) / 2.5 V Output ( $V_{DDO}$ ) clock distribution buffer with the capability to select either a differential LVPECL / LVDS / LVHSTL / SSTL / HCSL or single ended LVCMOS / LVTTL compatible input clock, such as a Primary or a Test Clock. All other control inputs (CLK\_SEL, CLK\_EN, and OE) are LVTTL/LVCMOS level compatible.

The NB3L83948C provides an enable input, CLK\_EN pin, which synchronously enables or disables the clock outputs while in the LOW state. Since this input is internally synchronized to the input clock, changing only when the input is LOW, potential output glitching or runt pulse generation is eliminated.

The 12 LVCMOS output pins drive 50  $\Omega$  series or parallel terminated transmission lines. The outputs can also be disabled to a high impedance (tri–stated) via the OE input, or enabled when High.

Fit, Form, and Function compatible with ICS83948I–147, ICS83948I–01, CY29948AXI, and MPC9448/9448L

#### Features

- 2.5 V / 3.3V (V<sub>DD</sub> = V<sub>DDO</sub>) or
   3.3 V V<sub>DD</sub> / 2.5 V V<sub>DDO</sub> Operation:
   2.5 ± 5%, 2.375 to 2.625 V
   3.3 ± 5%; 3.135 to 3.465 V
- 350 MHz Clock Support
- Accepts LVPECL, LVDS, LVHSTL, SSTL, HCSL, or LVCMOS Clock Inputs
- LVCMOS Compatible Control Inputs
- 12 LVCMOS Clock Outputs
- Synchronous Clock Select
- Output Enable to High Z State Control
- 100 ps Max. Skew Between Outputs
- Industrial Temp. Range –40°C to +85°C
- 32-pin LQFP Package
- These are Pb–Free Devices



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Figure 1. Simplified Logic Diagram

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 6 of this data sheet.



Figure 2. Pinout Configuration (Top View)

Pin	Name	I/O	Open Default	Description
1	CLK_SEL	LVTTL/LVCMOS Input	Pullup	Clock Select Input. When LOW, the CLK/CLK differential inputs are selected. When HIGH, LVCMOS_CLK is selected.
2	LVCMOS_CLK	LVTTL/LVCMOS Input	Pullup	Single ended Test Clock Input
3	CLK	LVPECL, LVDS, LVHSTL, SSTL, HCSL, or LVCMOS	Pullup	True Clock Input (internal)
4	CLK	LVPECL, LVDS, LVHSTL, SSTL, HCSL, or LVCMOS	Pulldown	Invert Clock Input
5	CLK_EN	LVTTL/LVCMOS Input	Pullup	Synchronous Clock Enable Input. When HIGH, outputs are enabled. When LOW, outputs are disabled (LOW).
6	OE	LVTTL/LVCMOS Input	Pullup	Output High Z State control. When HIGH, the outputs are active and enabled. When LOW, the outputs are high impedance disabled.
7	V <sub>DD</sub>	POWER		$V_{DD}$ Positive Supply pin for core logic. All $V_{DD}, V_{DDO}$ , and GND pins must be externally connected to a power supply to guarantee proper operation. Bypass with 0.01 $\mu F$ cap to GND.
8, 12, 16, 20, 24, 28, 32	GND	GND		GND Supply Ground. All $V_{DD}$ , $V_{DDO}$ and GND pins must be externally connected to power supply to guarantee proper operation.
9, 11, 13, 15, 17, 19, 21, 23, 25, 27, 29, 31	Q[11:0]	LVCMOS Output		Clock Output Pins
10, 14, 18, 22, 26, 30	V <sub>DDO</sub>	POWER		$V_{DDO}$ Positive Supply pins. All $V_{DD},V_{DDO}$ , and GND pins must be externally connected to a power supply to guarantee proper operation. Bypass each supply pin with 0.01 $\mu F$ to GND.

#### Table 2. CLOCK SELECT FUNCTION TABLE





The CLK\_EN control input synchronously enables or disables the outputs as shown in Figure 3. This control latches on the falling edge of the selected input CLK. When CLK\_EN is LOW, the outputs are disabled in a LOW state. When CLK\_EN is HIGH, the outputs are enabled as shown. CLK\_EN to CLK Set up and Hold times must be satisfied.

Table 3. ATTRIBUTES (Note 1)

Characteristics		Value			
Internal Input Pullup and Pulldown Resistor		50 kΩ			
ESD Protection	Human Body Model Machine Model	> 1.5 kV > 200 V			
Moisture Sensitivity (Note 1)		Level 2			
Flammability Rating Oxygen Index		UL-94 code V-0 A 1/8" 28 to 34			
Transistor Count	275 Devices				
Meets or exceeds JEDEC Spec	Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test				

1. For additional information, see Application Note AND8003/D.

#### Table 4. MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Condition	Rating	Unit
V <sub>DD</sub> /V <sub>DDO</sub>	Positive Power Supply	GND = 0 V	4.6	V
VI	Input Voltage		$-0.3 \le V_{I} \le V_{DD} + 0.3$	V
T <sub>A</sub>	Operating Temperature Range, Industrial		$-40 \text{ to } \le +85$	°C
T <sub>stg</sub>	Storage Temperature Range		-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	80 55	°C/W °C/W
θ <sub>JC</sub>	Thermal Resistance (Junction-to-Case)	(Note 3)	12–17	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

3. JEDEC standard multilayer board - 2S2P (2 signal, 2 power).

<sup>2.</sup> Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and not valid simultaneously. If stress limits are exceeded device functional operation is not implied, damage may occur and reliability may be affected.

Symbol	Characteristic	Min	Тур	Max	Unit
I <sub>DD</sub>	Quiescent Power Supply Current $3.3V V_{DD} = V_{DDO} \text{ or } 3.3 V V_{DD}, 2.5 V_{DDO}$ $2.5 V V_{DD} = V_{DDO}$			55 52	mA
V <sub>IH</sub>	Input HIGH Voltage at 3.465 V V <sub>DD</sub> CLK_SEL; LVCMOS_CLK, CLK_EN, OE	2.0		V <sub>DD</sub> +0.3	V
	Input HIGH Voltage 2.625 V <sub>DD</sub> CLK_SEL; LVCMOS_CLK, CLK_EN, OE	1.7		V <sub>DD</sub> +0.3	
V <sub>IL</sub>	Input LOW Voltage 3.465 V V <sub>DD</sub> CLK_SEL; LVCMOS_CLK, CLK_EN, OE	-0.3		0.8	V
	Input LOW Voltage 2.625 V V <sub>DD</sub> CLK_SEL; LVCMOS_CLK, CLK_EN, OE	-0.3		0.7	
I <sub>IN</sub>	Input Current (V <sub>IN</sub> = V <sub>DD</sub> )			300	μA
V <sub>OH</sub>	Output HIGH Voltage I <sub>OH</sub> = –24 mA $3.3 \text{ V} \pm 5\% = \text{V}_{\text{DD}} = \text{V}_{\text{DDO}}$	2.4			V
	Output HIGH Voltage I <sub>OH</sub> = -15 mA 3.3 V $\pm$ 5% or 2.5 V $\pm$ 5% = V <sub>DD</sub> ; 2.5 V +5% = V <sub>DDO</sub>	1.8			
V <sub>OL</sub>	Output LOW Voltage I <sub>OL</sub> = 24 mA $3.3 \text{ V} \pm 5\% = \text{V}_{\text{DD}} = \text{V}_{\text{DDO}}$			0.55	V
	Output LOW Voltage I <sub>OL</sub> = 12 mA $3.3 \text{ V} \pm 5\% = \text{V}_{\text{DD}} = \text{V}_{\text{DDO}}$			0.3	
	Output LOW Voltage I <sub>OL</sub> = 15 mA $0.3 \text{ V} \pm 5\% = \text{V}_{\text{DD}}; 2.5 \text{ V} \pm 5\% = \text{V}_{\text{DDO}}$			0.6	
V <sub>CMR</sub>	Common Mode Voltage Range (CLK/CLK) 3.3 V $\pm$ 5% or 2.5 V $\pm$ 5% = V <sub>DD</sub>	GND+0.5		V <sub>DD</sub> -0.85	V
V <sub>PP</sub>	Input Voltage (Peak–to–Peak) CLK/CLK 3.3 V $\pm 5\%$ or 2.5 V $\pm 5\%$ = V_DD	0.15		1.3	V
ZO	Output Impedance	5	7	12	Ω
C <sub>IN</sub>	Input Capacitance			4	pF
C <sub>PD</sub>	Power Dissipation Capacitance (per Output)		25		pF

**Table 5. DC CHARACTERISTICS**  $V_{DD} = V_{DDO} = 3.3 \pm 5\%$  (3.135 to 3.465 V) or 2.5 ± 5% (2.375 to 2.625 V);  $V_{DD} = 3.3 \pm 5\%$ (3.135 to 3.465 V) and  $V_{DDO} = 2.5 \pm 5\%$  (2.375 to 2.625 V) GND = 0 V,  $T_A = -40^{\circ}$ C to +85°C; (Note 4)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

4. Parallel terminated 50  $\Omega$  to V\_DDO/2. See Figure 5.

Symbol	Characteristic	Min	Тур	Мах	Unit
F <sub>max</sub>	Maximum Operating Frequency	350			MHz
t <sub>PLH</sub> /t <sub>PHL</sub>	Propagation Delay, (crosspoint to $V_{DDO}/2$ ) f $\leq$ 350 MHz				ns
	3.3 V V <sub>DD</sub> = V <sub>DDO</sub> or 3.3 V V <sub>DD</sub> , 2.5 V V <sub>DDO</sub> ; CLK/ $\overline{CLK}$ to Qx	1.6		3.6	ns
	3.3 V V <sub>DD</sub> = V <sub>DDO</sub> or 3.3 V V <sub>DD</sub> , 2.5 V V <sub>DDO</sub> ; 3.3 V LVCMOS_CLK to Qx	1.0		3.0	1
	2.5 V V <sub>DD</sub> = V <sub>DDO</sub> CLK/CLK to Qx	1.6		3.6	1
	$2.5 \text{ V} \text{ V}_{\text{DD}} = \text{V}_{\text{DDO}} \text{ LVCMOS}_{\text{CLK}}$ to Qx	1.0		3.0	
t <sub>PZL</sub> /t <sub>PZH</sub>	Output Enable Time OE to Qx			5	ns
t <sub>PLZ</sub> /t <sub>PHZ</sub>	Output Disable Time OE to Qx			5	ns
tSKEW <sub>DC</sub>	Duty Cycle Skew at V <sub>DD</sub> / 2 At 150 MHz; $3.3 \vee V_{DD} = V_{DDO}$ At 200 MHz; $2.5 \vee V_{DD} = V_{DDO}$ At 150 MHz; $2.5 \vee V_{DD} = V_{DDO}$	45 45 40		55 55 60	%
tSKEW <sub>D-D</sub>	Device to Device Skew (similar condition) CLK/CLK to Qx; CLK to Qx			1.0	ns
tSKEW <sub>O-O</sub>	Output to Output Skew Within A Device		25	100	ps
t <sub>S</sub>	Set-up Time to CLK tf CLK_EN to CLK/CLK CLK_EN to CLK	1.0 0.0			ns
t <sub>H</sub>	Hold Time to CLK tf CLK/CLK to CLK_EN CLK to CLK_EN	0.0 1.0			ns
tr/tf	Output rise and fall times $(0.8 \text{ V and } 2.0 \text{ V}) 3.3 \text{ V } \text{V}_{\text{DD}} = \text{V}_{\text{DDO}}$ $(0.6 \text{ V and } 1.8 \text{ V}) \text{ or } 3.3 \text{ V } \text{V}_{\text{DD}}, 2.5 \text{ V}_{\text{DDO}}$ $(0.6 \text{ V and } 1.8 \text{ V}) 2.5 \text{ V } \text{V}_{\text{DD}} = \text{V}_{\text{DDO}}$			1.0 1.0 1.3	ns

<b>Table 6. AC CHARACTERISTICS</b> $V_{DD} = V_{DDO} = 3.3 \pm 5\%$ (3.135 to 3.465 V) or 2.5 ± 5% (2.375 to 2.625 V); $V_{DD} = 3.3 \pm 5\%$
(3.135 to 3.465 V) and V <sub>DDO</sub> = 2.5 $\pm$ 5% (2.375 to 2.625 V) GND = 0 V, T <sub>A</sub> = -40°C to +85°C; (Note 5)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

values are applied individually under normal operation on the device exceeding these conductris is not implied. Device specification inner values are applied individually under normal operating conditions and not valid simultaneously. 5. Outputs loaded with 50  $\Omega$  to V<sub>TT</sub> (V<sub>DDO</sub>/2); see Figure 5. CLOCK input with 50% duty cycle. Measured at CLK/CLK crosspoint to Qx V<sub>DDO</sub>/2, CLK V<sub>DDO</sub>/2 to Qx V<sub>DDO</sub>/2; see Figure 4.



Figure 4. AC Reference Measurement



Figure 5. Typical Termination for Output Driver and Device Evaluation. Supplies may be centered on GND  $(\pm 1.65 \text{ V or } \pm 1.25 \text{ V})$  to permit direct connection into 50  $\Omega$  to GND Scope modules

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NB3L83948CFAG	LQFP-32 (Pb-Free)	250 Units / Tray
NB3L83948CFAR2G	LQFP-32 (Pb-Free)	2000 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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